



Electrical Characteristics (T₁=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC I	PARAMETERS						-
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V		60			V
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =60V, V_{GS} =0V				1	
			TJ=55°C			5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V				±100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		1.5	2	2.5	V
I _{D(ON)}	On state drain current	V_{GS} =10V, V_{DS} =5V		30			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =6A			36	44	
			T _J =125°C		61.5	75	mΩ
		V _{GS} =4.5V, I _D =4A			42	53	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =6A			21		S
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.75	1	V
ls	Maximum Body-Diode Continuous Cu	rent				3.5	А
DYNAMI	C PARAMETERS						-
Ciss	Input Capacitance	V _{GS} =0V, V _{DS} =30V, f=1MHz			426		pF
C _{oss}	Output Capacitance				50		pF
C _{rss}	Reverse Transfer Capacitance				5		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		1	2.3	3.5	Ω
	NG PARAMETERS	•					<u>8</u>
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =6A			6.1	12	nC
Q _g (4.5V)	Total Gate Charge				2.6	6	nC
Q _{gs}	Gate Source Charge				1.2		nC
Q _{gd}	Gate Drain Charge				0.8		nC
t _{D(on)}	Turn-On DelayTime	V_{GS} =10V, V_{DS} =30V, R_{L} =5 Ω , R_{GEN} =3 Ω			3		ns
t _r	Turn-On Rise Time				2.5		ns
t _{D(off)}	Turn-Off DelayTime				15		ns
t _f	Turn-Off Fall Time				1.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =6A, dI/dt=100A/μs			27		ns
Q _{rr}	Body Diode Reverse Recovery Charge	l _F =6A, dl/dt=100A/μs			12		nC

A. The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The Power dissipation P_{DSM} is based on R_{0JA} t \leq 10s value and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)} = 150^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initial T_J=25° C.

D. The $R_{\rm 0JA}$ is the sum of the thermal impedance from junction to case $R_{\rm 0JC}$ and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max. F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

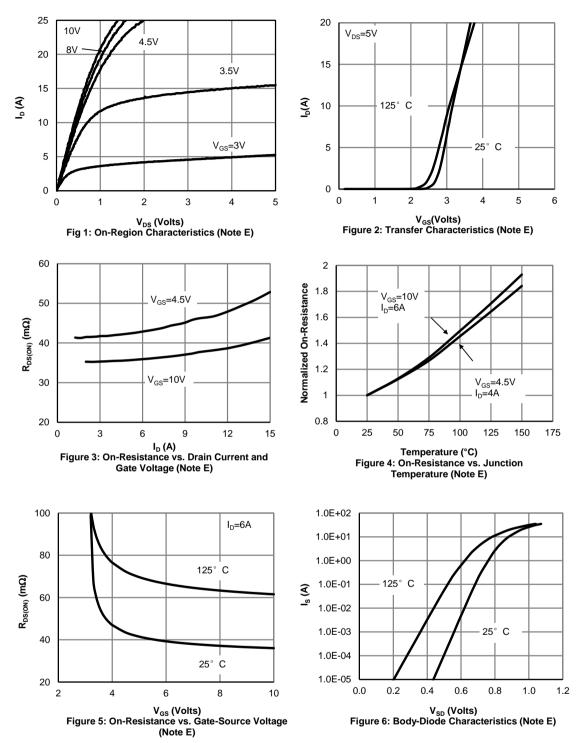
H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C.

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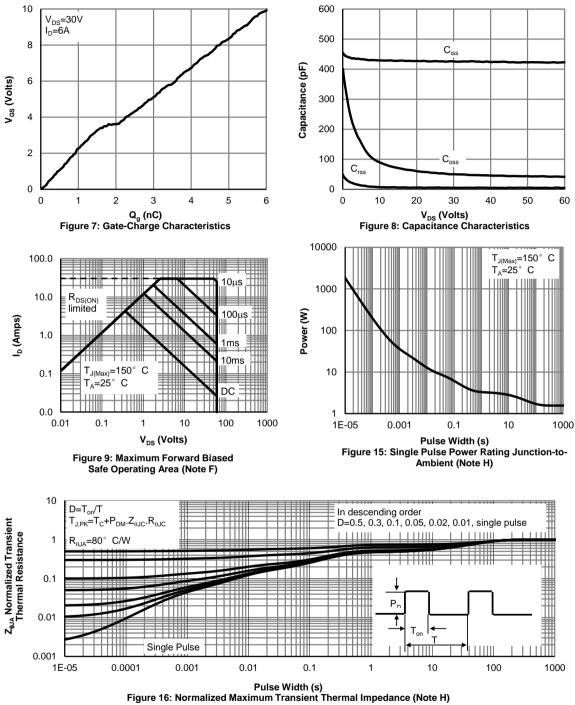


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





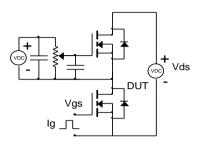
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

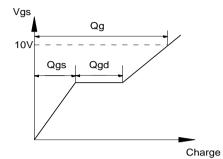




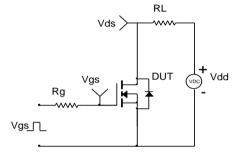


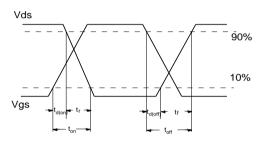
Gate Charge Test Circuit & Waveform



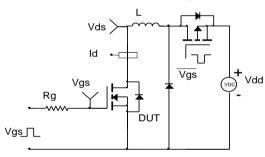


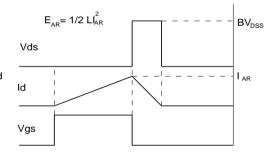
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

